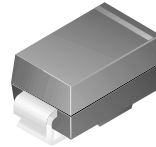


# RGF1A - RGF1M

## Features

- Glass passivated junction.
- For surface mounted application.
- Low forward voltage drop.
- High current capability.
- Easy pick and place.
- High surge current capability.



**SMA/DO-214AC**  
COLOR BAND DENOTES CATHODE

## Fast Rectifiers

### Absolute Maximum Ratings\*

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Value							Units
		1A	1B	1D	1G	1J	1K	1M	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
$I_{F(AV)}$	Average Rectified Forward Current, @ $T_J = 125^\circ\text{C}$	1.0							A
$I_{FSM}$	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	30							A
$T_{stg}$	Storage Temperature Range	-65 to +175							$^\circ\text{C}$
$T_J$	Operating Junction Temperature	-65 to +175							$^\circ\text{C}$

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

## Thermal Characteristics

Symbol	Parameter	Value	Units
$P_D$	Power Dissipation	1.76	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	85	$^\circ\text{C/W}$
$R_{\theta JL}$	Thermal Resistance, Junction to Lead*	28	$^\circ\text{C/W}$

\*Device mounted on FR-4 PCB 0.013 mm.

## Electrical Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Device							Units
		1A	1B	1D	1G	1J	1K	1M	
$V_F$	Forward Voltage @ 1.0 A	1.3							V
$t_{rr}$	Reverse Recovery Time $I_F = 0.5\text{ A}$ , $I_R = 1.0\text{ A}$ , $I_{rr} = 0.25\text{ A}$	150			250		500		ns
$I_R$	Reverse Current @ rated $V_R$ $T_A = 25^\circ\text{C}$ $T_A = 125^\circ\text{C}$	5.0 100							$\mu\text{A}$ $\mu\text{A}$
$C_T$	Total Capacitance $V_R = 4.0\text{ V}$ , $f = 1.0\text{ MHz}$	8.5							pF

Typical Characteristics

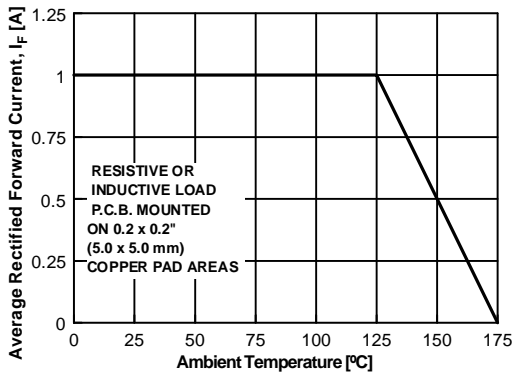


Figure 1. Forward Current Derating Curve

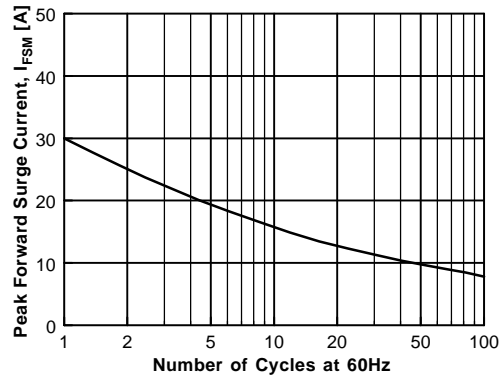


Figure 2. Non-Repetitive Surge Current

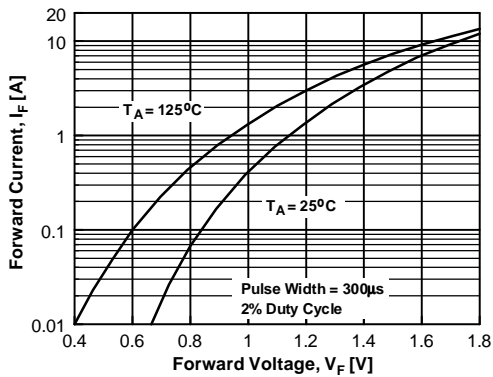


Figure 3. Forward Voltage Characteristics

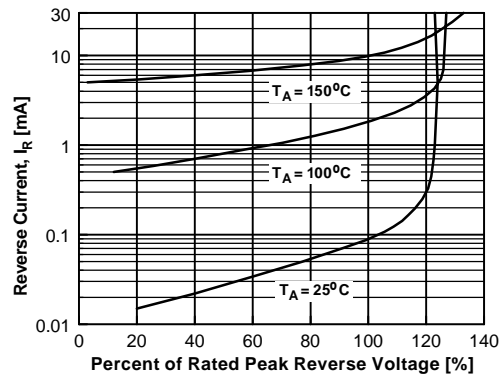


Figure 4. Reverse Current vs Reverse Voltage

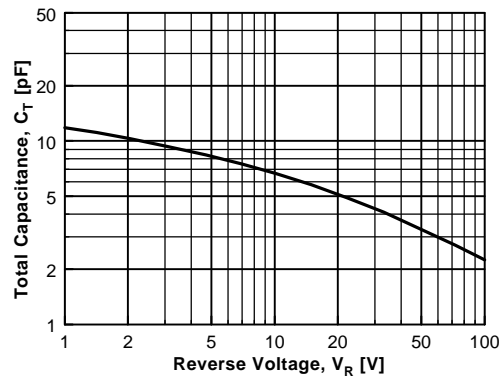


Figure 5. Total Capacitance

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